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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/050,165	01/18/2002	Katsuhiko Fukasaku	NE253-US	7604	
7	590 04/21/2004		EXAMINER		
McGinn & Gibb, PLLC 8321 Old Courthouse Road, Suite 200			IM, JUNGHWA M		
Vienna, VA	•		ART UNIT PAPER NUMBER		
			2811		
			DATE MAILED: 04/21/2004		

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)			
Office Action Commons		10/050,165	FUKASAKU, KATSUHIKO			
	Office Action Summary	Examiner	Art Unit	-		
		Junghwa M. Im	2811			
Period fo	The MAILING DATE of this communication app r Reply	ears on the cover sheet with the c	orrespondence address	S		
THE N - Exten after: - If the - If NO - Failur Any r	DRTENED STATUTORY PERIOD FOR REPLY MAILING DATE OF THIS COMMUNICATION. Sisions of time may be available under the provisions of 37 CFR 1.13 SIX (6) MONTHS from the mailing date of this communication. period for reply specified above is less than thirty (30) days, a reply period for reply is specified above, the maximum statutory period we to reply within the set or extended period for reply will, by statute, eply received by the Office later than three months after the mailing and patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a reply be timed within the statutory minimum of thirty (30) days will apply and will expire SIX (6) MONTHS from a cause the application to become ABANDONEI	rely filed s will be considered timely. the mailing date of this commun D (35 U.S.C. § 133).	nication.		
Status						
1)⊠	Responsive to communication(s) filed on 09 Ja	nuary 2004.				
2a)⊠	This action is FINAL . 2b) ☐ This	action is non-final.				
,	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.					
Dispositi	on of Claims					
5)□ 6)⊠ 7)□	4) Claim(s) 1-3,7,8 and 11-23 is/are pending in the application. 4a) Of the above claim(s) is/are withdrawn from consideration. 5) Claim(s) is/are allowed. 6) Claim(s) 1-3, 7, 8 and 11-23 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/or election requirement.					
Application	on Papers					
9) The specification is objected to by the Examiner.						
10)☐ The drawing(s) filed on is/are: a)☐ accepted or b)☐ objected to by the Examiner.						
	Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).					
	Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d). 11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.					
Priority u	nder 35 U.S.C. § 119					
a)[Acknowledgment is made of a claim for foreign All b) Some * c) None of: 1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the prior application from the International Bureau ee the attached detailed Office action for a list of	s have been received. s have been received in Application ity documents have been receive (PCT Rule 17.2(a)).	on No d in this National Stag	e		
Attachment	• •	_				
	e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (PTO-948)	4) Interview Summary (Paper No(s)/Mail Da				
3) 🔲 Inform	nation Disclosure Statement(s) (PTO-1449 or PTO/SB/08) No(s)/Mail Date		atent Application (PTO-152)			

Art Unit: 2811

DETAILED ACTION

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1-3, 7, 8, 11, 12, 19, 22 and 23 are rejected under 35 U.S.C. 103(a) as being unpatentable over Yamane et al. (US 6020229), hereafter Yamane in view of Chien et al. (US 6432768).

Regarding claims 1-3, 7, 8, 11 and 12, Fig.10 of Yamane shows a semiconductor device comprising:

a plurality of transistors on formed on a substrate (201) comprising 1/O-purpose MOSFET (col. 8, lines 38-40) with a thicker gate insulator film (30nm) and a thicker gate electrode (200nm) than a core-purpose MOSFET (LV transistor; col.9, line 5) which has a thickness of 10nm for a gate insulator film and 100nm for a gate electrode; and the said gate electrode includes an impurity to suppress depletion when forming a source region and a drain region (col. 5, lines 46-59; col. 6, lines 58-60; col.8, lines 42-44).

Yamane fails to show a device having a Ldd formation with a depth corresponding the thickness of the gate and the gate insulator film. Fig. 1F of Chien shows Ldd regions (132, 116) for gates corresponding to the thickness of the gate and the gate insulator film. It would have been obvious to one of ordinary skill to use the teaching of Chien to the device of Yamane in

Art Unit: 2811

order to have Ldd regions since a Ldd structure performs functions of increasing the breakdown voltage, migrating of the hot carriers and inhibiting short channel effect.

In detail, Fig. 1F of Chien shows that a thicker gate (112) with a deeper Ldd region(116) and a thinner gate(124) with a shallow Ldd region(134). It would be obvious that a deeper Ldd region is formed with a thicker gate since the Ldd region of Chien is formed using the gate as a mask (col. 2, line 51- col. 3, line 20).

Regarding claim 19, Fig. 1F of Chen shows a device comprising a plurality of sidewalls and a thicker gate having a higher sidewalls.

Regarding claims 22 and 23, Fig.10 of Yamane shows a semiconductor device comprising:

a plurality of transistors on formed on a substrate (201) comprising 1/O-purpose MOSFET (col. 8, lines 38-40) with a thicker gate insulator film (30nm) and a thicker gate electrode (200nm) than a core-purpose MOSFET (LV transistor; col.9, line 5) which has a thickness of 10nm for a gate insulator film and 100nm for a gate electrode; and the said gate electrode includes an impurity to suppress depletion when forming a source region and a drain region (col. 5, lines 46-59; col. 6, lines 58-60; col.8, lines 42-44).

Yamane fails to show a device having a Ldd formation with a depth corresponding the thickness of the gate and the gate insulator film. Fig. 1F of Chien shows Ldd regions (132, 116) for gates corresponding to the thickness of the gate and the gate insulator film. It would have been obvious to one of ordinary skill to use the teaching of Chien to the device of Yamane in order to have Ldd regions since a Ldd structure performs functions of increasing the breakdown voltage, migrating of the hot carriers and inhibiting short channel effect.

Art Unit: 2811

Fig. 1F of Chien shows that a thicker gate(116) with a deeper Ldd region(116) and a thinner gate(124) with a shallow Ldd region(134). It would be obvious that a deeper Ldd region is formed with a thicker gate since the Ldd region of Chien is formed using the gate and the sidewall as a mask (col. 2, line 51- col. 3, line 20). And it would have been obvious to one of ordinary skill to incorporate the teaching of Chien to the device of Yamane to use the gate and the sidewall as a mask to form a Ldd region for self-aligning advantage.

Claims 13-18, 20 and 21 are rejected under 35 U.S.C. 103(a) as being unpatentable over Yamane and Chien as applied to claim 1 above, and further in view of Tsao et al. (US 6143594), hereafter Tsao.

Regarding claims 13 and 14, the combined teaching of Yamane and Chien shows substantially the entire claimed structure except the device polarity and the supply voltages. Fig. 1F of Tsao shows a core NMOS and a high voltage NMOS(an I/O purpose NMOS).

The teachings of Yamane and Chien do not show the supply voltage for the core and I/O devices. Tsao shows the operating voltages for core device and the high voltage device. It would have been obvious to one of ordinary skill to use the teaching of Tsao to the device of Yamane and Chien in order to obtain proper operating voltages for electrical function of the device. And it would be obvious to use NMOS for the device of Yamane and Chien since an NMOS is most commonly used for a semiconductor device.

In addition, it would have been obvious to one of ordinary skill in the art at the time of the invention to have an intended supply voltage as recited in pending claim, since it has been

Art Unit: 2811

held that discovering an optimum value of a result effective variable involves only routine skill in the art. *In re Boesch*, 617 F.2d 272, 205 USPQ 215 (CCPA 1980).

Regarding claims 15, 17 and 20, Fig. 1F of Tsao shows a P-well formation (102) in a core NMOS region and a high voltage NMOS region along with Ldd regions. It is well known in the art that phosphorous and arsenic are is the most commonly used material for N-type impurity. Also see a respective portion of Mori et al. (US 6376879) for impurity material.

Note that "implant" is a is a process designation and would thus not carry patentable weight in his claim drawn to a product. See *In re Thorp*, 227 USPQ 964 (Fed. Cir. 1985).

Regarding claims 16, 18 and 21, Tsao discloses a density at energy level for HV transistor and LV transistor. In addition it would have been obvious to one of ordinary skill in the art at the time of the invention made to have an intended value for a density for phosphorous and arsenic in a HV and a LV regions as claimed, since it has been that where the general conditions of a claim are disclosed in the prior art, discovering the optimum or workable ranges involves only in routine skill in the art. *In re Boesch*, 617 F.2d 272, 205 USPQ 215 (CCPA 1980).

Response to Arguments

Applicant's arguments filed January 10, 2004 have been fully considered but they are not persuasive.

Applicant argues that the devices of Yamane and Chien are not compatible to incorporate the teachings to one another. And the similar argument is made against the device of Tsao.

Art Unit: 2811

However, all three of the devices are used for memory applications with essentially the same transistor structure while having a modification in a core element of the transistor structure such as a gate or a source/a drain. It is pointed out that Applicant's speculation/assumption over the particular functionality on the devices does not carry a patentable weight for a device claim.

Applicant further contends that Yamane dose not disclose Ldd regions, however, this deficiency is complemented with the Chien's reference. On the contrary to Applicant contention that Chien does not explain why the Ldd regions are provided, Chien explicitly teaches that a Ldd region is formed by implantation through using a gate as a mask. Therefore, it follows that a higher the gate structure is, the deeper the Ldd region is. Additionally, it is known to one of ordinary skill in the art that Ldd regions are provide to have an advantage stated in the Office Action above.

Finally, an allegation regarding hindsight considerations, it is noted hat Examiner's conclusion of obviousness is based on a reconstruction through *permissible* hindsight reasoning. For the conclusion of obviousness presented above, Examiner relied only on the knowledge that was available to one of ordinary in the art at the time of invention, not including knowledge gleaned only form the Applicant's disclosure.

Conclusion

THIS ACTION IS MADE FINAL. Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO

Art Unit: 2811

MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Junghwa M. Im whose telephone number is (571) 272-1655. The examiner can normally be reached on MON.-FRI. 8:30AM-5:00PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Eddie C Lee can be reached on (571) 272-1732. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

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